

## Title of the Invention

### Housing Structure of Vehicle-Mounted Electronic Equipment

## Background of the Invention

### 5 1. Field of the Invention

The present invention relates to a housing structure of vehicle-mounted electronic equipment for hermetically accommodating an electronic substrate between a set of cover and base and, more particularly, to a heat resistant, water resistant  
10 (waterproof) and vibration resistant housing structure suitable for mass-production.

### 2. Description of the Related Art

Hitherto, a housing structure is comprised of two pieces in which connectors are integrally formed into one body and an upper  
15 case (cover) made of resin, to which an electronic substrate is fixed, is adhesively fixed onto a lower case (base) with an adhesive sealant (see, for example, the Japanese Patent Publication (unexamined) No. 1999-346418).

20 In another example of conventional housing structure comprised of two pieces, an electronic substrate is accommodated in a housing formed of a case and a cover, and a heat generated by any heating part mounted on the electronic substrate is transferred to the cover and dissipated (see, for example, the Japanese Patent  
25 Publication (unexamined) No. 1996-148842).

In a further example, a fire retardant resin made of polybutyleneterephthalate resin mixed with glass fiber reinforcement is employed as vehicle-mounted electrical and electronic parts (see, for example, the Japanese Patent Publication  
30 (unexamined) No. 2000-178417).

With regard to heat dissipation from any heating part, a structure is known, in which a heat generated by any heating part fixed onto one face of a double-sided substrate is transferred to the other face via a through-hole-plated hole. The substrate is  
5 fixed onto a part of a heat-transfer housing through a heat-transfer elastic-insulating sheet (see, for example, Japanese Patent Publication (unexamined) No. 1996-204072).

In a still further example of a conventional structure, a heat generated by any heating part mounted on an electronic substrate  
10 is transferred to a cooling member such as aluminum base and dissipated (see, for example, the Japanese National Publication No. 2001-505000).

While improvement in dissipation of heat generated by the heating part becomes important under the background of highly  
15 miniaturizing and integrating the electronic substrate, vehicle-mounted electronic equipment is required to satisfy various requirements such as heat resistance, water resistance, vibration resistance, and mass-production.

However, in the above-mentioned Japanese Patent Publication  
20 (unexamined) No. 1999-346418, a problem exists in that the structure is not so constructed as to dissipate any heat generated by the heating part mounted on the electronic substrate.

Another problem exists in that it is not possible to obtain sufficient vibration resistance just by bonding the cover with the  
25 base and, moreover, heat resistance and sealing property of the finished products is not always sufficient.

In the structure of the above-mentioned Japanese Patent Publication (unexamined) No. 1996-148842, several problems exist in that any contact pressure is not sufficiently secured between  
30 the heating part and the cover, and the heat generated by a large

number of heating parts is difficult to be dissipated. The entire structure is not sufficiently waterproof, either.

#### Summary of the Invention

5       The present invention has been made to solve the above-discussed problems and has an object of providing a housing structure that is capable of improving dissipation of heat generated by any heating part and vibration resistance, being mass-produced, accommodating a miniaturized and highly integrated electronic  
10       substrate in the housing structure. The housing structure is further capable of being installed in an engine room of a vehicle, and being superior in heat resistance and waterproof.

      A housing structure of vehicle-mounted electronic equipment of the invention includes a connector housing into which a large  
15       number of contact pins are press-fitted and a counter-connector is inserted, a cover that is integrally formed with the connector housing of a fire retardant resin and is provided with a canopy part and an annular circumferential wall part, an electronic substrate temporarily fixed onto an inner wall of the annular circumferential  
20       wall part, and to which the contact pins are connected, and a highly heat-transfer base that is disposed in contact with the electronic substrate so that a heat generated by any heating part mounted on the electronic substrate is transferred and dissipated, and is provided with mounting lugs for mounting the base on a vehicle body.  
25       In this housing structure, the annular circumferential wall part is provided with an annular groove in which a sealant is inserted and plural screw holes located at the outside of the annular groove. The base is provided with an annular protrusion snapped into the annular groove and plural through holes located at the outside of  
30       the annular protrusion. By inserting fixing screws into the screw

holes through the through holes, the electronic substrate is held between the annular circumferential wall part and the base.

As a result, the heating parts disposed on the electronic substrate are fitted on the base so that heat is securely transferred to the base, and vibration resistance is improved by mounting a heavy base on the vehicle body.

The sealant inserted between the cover formed of a fire retardant resin and the base is brought into tight contact with the cover and the base by the integration means. This brings about an advantage of improving the housing structure in the aspect of heat resistance and vibration resistance making the housing structure hermetically sealed and waterproof without fail.

#### Brief Description of the Drawings

Fig. 1 is a plan view showing a housing structure of vehicle-mounted electronic equipment covered with a canopy part according to Embodiment 1 of the present invention;

Fig. 2 is a plan view showing the housing structure of vehicle-mounted electronic equipment not covered with a canopy part according to Embodiment 1 of the invention;

Fig. 3 is a side view showing the housing structure of vehicle-mounted electronic equipment according to Embodiment 1 of the invention;

Fig. 4 is a sectional view taken along the line B-B in Fig. 1;

Fig. 5 is a sectional view taken along the line C-C in Fig. 3;

Fig. 6 is a sectional view taken along the line D-D in Fig. 3;

Fig. 7 is an enlarged sectional view showing a connector

part; and

Fig. 8 is a sectional view taken along the line E-E in Fig. 4;

5                   Description of the Preferred Embodiments  
Embodiment 1.

An embodiment according to the present invention is hereinafter described with reference to the accompanying drawings.

Fig. 1 is a plan view showing a housing structure of  
10 vehicle-mounted electronic equipment according to Embodiment 1 of the invention, and Fig. 2 is a plan view showing the housing structure in which a canopy part is removed from the state of Fig. 1. Fig. 3 is a side view taken in the direction of A in Fig. 1, Fig. 4 is a sectional view taken along the line B-B in Fig. 1, and Fig. 5 is  
15 a sectional view taken along the line C-C in Fig. 3. Fig. 6 is a sectional view taken along the line D-D in Fig. 3, Fig. 7 is an enlarged sectional view showing a connector part, and Fig. 8 is a sectional view taken along the line E-E in Fig. 4.

In the drawings, a large number of contact pins 2 are  
20 press-fitted into a cover 1, and the cover 1 and a connector housing 4 in which a counter-connector 3 is inserted are integrally formed of a fire retardant resin. The cover 1 is provided with a canopy part 5 and an annular circumferential wall part 6. After the electronic substrate 7 is temporarily fixed onto an inner wall of  
25 the annular circumferential wall part 6, the mentioned many contact pins 2 are connected to an electronic substrate 7. A highly heat-transfer base 8 is disposed in contact with the electronic substrate 7 in such a manner that a heat generated by the heating part 9 mounted on the electronic substrate 7 is transferred and  
30 dissipated. The highly heat-transfer base 8 is provided with

mounting lugs 10 for mounting the base 8 on a vehicle body.

A sealant 11 is inserted between the annular circumferential wall part 6 and the base 8 to surround the electronic substrate 7. Integration means is provided on the outside of the sealant 11 in  
5 order to fix the annular circumferential wall part 6 on the base 8. Thus the electronic substrate 7 is held between the annular circumferential wall part 6 and the base 8 by this integration means.

In this manner, by using the integration means, the base 8, which is a first heavy body, is directly mounted on the vehicle body  
10 and the electronic substrate 7, which is a second heavy body, is directly mounted on the base 8. As a result, a heat generated by the heating parts 9 is transferred and dissipated, and vibration resistance at the time of mounting is improved. Furthermore, thermal deformation stress of the connector housing 4, which is a molded  
15 member, is not applied onto the electronic substrate 7 by the integration means.

The sealant 11 disposed between the base 8 and the connector housing 4 makes the housing structure waterproof, and the base 8 and the connector housing 4 are integrated by the integration means  
20 for improving the vibration resistance.

As described above, the highly heat-transfer base 8 and the cover 1 are integrally mounted inserting the electronic substrate 7 between them. As a result, the heating parts 9 disposed on the electronic substrate 7 can be mounted on the base 8 in such a manner  
25 as to transfer the heat without fail. Furthermore, the vibration resistance of the housing structure is improved by mounting the heavy base 8 on the vehicle body.

The sealant 11 inserted between the cover 1 formed of fire retardant resin and the base 8 are tightly fitted on the cover 1  
30 and the base 8 by the integration means. As a result, advantages

are obtained such that heat resistance and vibration resistance are superior and the housing structure is hermetically sealed and waterproof without fail.

The cover 1 provided with the connector housing 4 is formed  
5 of a fire retardant resin. This fire retardant resin is composed  
of polybutyleneterephthalate resin used as base material, and 15  
to 40 % by weight of glass filler as filler. The base 8 is formed  
by aluminum die-casting, and an adhesive sealant made of a  
room-temperature-setting liquid silicone rubber is used as the  
10 sealant 11.

Therefore, the molded connector portion is dimensionally  
stable, and it is possible to flexibly cope with the contact pins  
2 press-fitted into the connector housing 4.

PBT (polybutylene terephthalate) contains neither nitrogen  
15 nor sulfur that spoils adhesive property of the liquid silicone  
rubber composing the sealant 11, and there is no problem in adhering  
the sealant 11 to the base 8.

The annular circumferential wall part 6 is provided with an  
annular groove 6a in which the sealant 11 is inserted and plural  
20 screw holes 12 located on the outside of the annular groove 6a. The  
base 8 is provided with an annular protrusion 13 snapped into the  
annular groove 6a and plural through holes 14 located on the outside  
of the annular protrusion 13. The integration means is comprised  
of a fixing screw 15 screwed into the screw holes 12 through the  
25 through hole 14.

This construction is suitable for fixing the connector housing  
4 with the fixing screw 15 from underside of the base 8, seal area  
of the sealant 11 is secured, and the sealant 11 is inserted in the  
annular groove 6a. Therefore the sealant 11 is suitably fitted.  
30 This construction has a further advantage of enlarging the contact

area of the sealant thereby sealing the housing more hermetically, even in case of the annular circumferential wall part 6 small in thickness.

Since the fixing screws 15 are located outside the annular groove 6a, there is an advantage that it is not required for the fixing screw 15 parts to be waterproof-treated.

The electronic substrate 7 is so constructed as to be temporarily fixed by press-fitting a press-fitting protrusion 16 provided on the inner wall of the annular circumferential wall part 6 into a mounting hole 17 provided on the electronic substrate 7.

Accordingly, it is possible to temporarily fix the electronic substrate 7 easily onto the cover 1 just by fitting the mounting hole 17 with the press-fitting protrusion 16. As a result, there is an advantage of positioning the contact pins 2 accurately at the time of connecting the contact pins 2 by soldering.

Copper-foil area 18 located on the underside of the electronic substrate 7 is electrically connected to the heating part 9 provided on the upper face of the electronic substrate 7, and a heat-transfer soft insulating layer 19 covers the copper-foil area 18. Furthermore, the base 8 is provided with a heat-transfer protrusion 20, and the mentioned integration means press-fits the soft insulating layer 19 onto the heat-transfer protrusion 20.

As a result, this construction has an advantage of efficiently transferring a heat generated by the heating parts 9 mounted on the electronic substrate 7 to the highly heat-transfer base 8.

Further, employing any room-temperature-setting liquid silicone rubber filled with a heat-transfer filler or a heat-transfer elastic insulating sheet as the soft insulating layer 19 provides an advantage of accurately transferring a heat generated in each of the plural copper-foil areas 18 corresponding to the plural



heating parts 9 mounted on the electronic substrate 7 to the highly heat-transfer base 8.

The cover 1 is provided with a column 22, which is provided with a central screw hole 21 with one end thereof blocked, substantially at the central position of the canopy part 5 thereof. The base 8 is provided with a pedestal 23 on which the electronic substrate 7 is placed and a central through hole 24 passing through this pedestal 23 substantially at the central position thereof.

The cover 1, the electronic substrate 7, and the base 8 are integrally formed and reinforced by a central fixing screw 25 screwed into the central screw hole 21 through the mentioned central through hole 24, and a waterproof sealant 26 is applied to the head of the central fixing screw 25.

Thus, at the time of installing the electronic substrate 7 of a relatively large area, the cover 1 and the base 8 are integrally formed and reinforced, thereby improving the vibration resistance, and the central pedestal 23 portion located at the center of the electronic substrate 7 can be utilized as a protrusion for transferring heat of the heating part 9.

The mentioned construction is hereinafter described in more detail.

The highly heat-transfer base 8 formed by aluminum die-casting is provided with the annular protrusion 13 and is also provided with mounting lugs 10a to 10d at four portions. These mounting lugs 10a to 10d are respectively provided with mounting holes 27a to 27d.

Mounting screws not shown in the drawings are inserted in the mounting holes 27a to 27d of the base 8 so that the base 8 is fitted and fixed onto the vehicle body not shown.

The cover 1 formed of, for example, a fire retardant resin, being composed of PBT (polybutyleneterephthalate) as base material

and 15 to 40 % by weight of glass filler as filler, includes a pair of connector housings 4a and 4b and a large number of bent-type (right angle type) contact pins 2a and 2b press-fitted in the connector housings 4a and 4b.

5       The annular circumferential wall part 6 and the cover 1 are integrally formed into one body, and this annular circumferential wall part 6 is provided with the annular groove 6a into which the annular projection 13 is snapped. The cover 1 is provided with the canopy part 5 and also with the screw holes 12a to 12d in which the  
10       fixing screws 15 are screwed at four corners thereof. In addition, the annular circumferential wall part 6 is provided with a partition wall 28.

      Further, the central screw hole 21 is disposed at an end part of the column 22 located substantially at the central position of  
15       the canopy part 5, and the central fixing screw 25 is screwed in this central screw hole 21.

      The heating parts 9 are mounted on the electronic substrate 7 made of, for example, glass epoxy material, on which a large number of electronic parts 9 are mounted. The mentioned large number of  
20       contact pins 2a and 2b are connected to the electronic substrate 7 by soldering.

      Referring to Fig. 5, the press-fitting protrusion part 16 located on the annular circumferential wall part 6 is press-fitted into the mounting hole 17 provided on the electronic substrate 7.  
25       The canopy part 5 is provided with the column 22 substantially at the central position thereof, and the column 22 is provided with the central screw hole 21 at the end part thereof.

      The base 8 is provided with the pedestal 23 substantially at the central position thereof, and the pedestal 23 is provided with  
30       the central through hole 24. Further, the electronic substrate 7

is provided with a mounting hole 29 substantially at the central position thereof.

The central fixing screw 25 passes through the mounting hole 29 from the central through hole 24 and is screwed into the central screw hole 21, and the waterproof sealant 26 is applied to the head of the central fixing screw 25.

Referring to Fig. 6, the base 8 is provided with the through holes 14 at four corners thereof, and the annular circumferential wall part 6 is provided with a screw hole 12 through a metal insert 30 integrally formed at four corners of the circumferential wall part 6. The fixing screw 15 is screwed into the screw hole 12 through the through hole 14.

The sealant 11 is inserted into the annular groove 6a and pressed by the annular protrusion 13. A material such as room-temperature-setting liquid silicone rubber is used as the sealant 11.

Referring now to Fig. 7, the counter-connector 3 is inserted into the connector housings 4a and 4b, and a large number of female pins not shown are inserted in the counter-connector 3 so as to be in contact and fitted with the contact pins 2a and 2b.

The counter-connector 3 is provided with an annular groove 31. This annular groove 31 is so formed as to sandwich the connector housings 4a and 4b, and elastic packing 32 made of a material such as rubber is mounted on inside of the annular groove 31.

Referring now to Fig. 8, the copper-foil area 18 is electrically connected to the heating part 9 mounted on the electronic substrate 7 and is located on the reverse side of the electronic substrate 7. The heat-transfer soft insulating layer 19 is disposed on the underside of the copper-foil area 18, and the heat-transfer protrusion 20 is provided on the base 8.

The soft insulating layer 19 is pressed by fixing the cover 1 onto the base 8 with the fixing screw 15 and is in contact with the heat-transfer protrusion 20 for transfer and dissipation of heat.

Heat generated by the heating parts 9 is transferred to the copper-foil area 18 through a connecting lead wire 33, through-hole-plated portion formed between double-sided substrate, and so on.

In the housing structure of above construction, a large number of electronic parts including the mentioned many heating parts 9 are packaged on the electronic substrate 7. Then, after the mounting hole 17 of the electronic substrate 7 being press-fitted and temporarily fixed onto the press-fitting protrusion 16 of the cover 1, into which the mentioned large number of contact pins 2a and 2b are press-fitted, the contact pins 2a and 2b are soldered onto the electronic substrate 7 using a jet soldering apparatus or the like.

Subsequently, after the adhesive sealant 11 made of a material such as room-temperature-setting liquid silicone rubber being injected into the annular groove 6a with the canopy part 5 side of the cover 1 facing downward, the base 8 is placed on the cover 1, and the electronic substrate 7, the base 8, and the cover 1 are screwed up together and integrally fixed by the fixing screw 15 and the central fixing screw 25.

Thereafter, the waterproof sealant 26 is applied in order to waterproof the head of the central fixing screw 25.

In the mentioned assembling process, since the electronic substrate 7 is press-fixed onto the base 8 by the annular circumferential wall part 6 with the use of the fixing screw 15, thermal deformation stress of the cover 1 does not cause any distortion of the electronic substrate 7 even when such stress acts thereon.

Likewise, the electronic substrate 7 is free from vibration load acting on the cover 1.

At the time of mounting a finished product on a vehicle body, the product is placed and fixed through the mounting lugs 10a to  
5 10d of the mechanically strong and heavy base 8, and then the counter-connector 3 is inserted in the connector housings 4a and 4b at the time of wiring work.

While the construction described above shows an example where an adhesive sealant composed of liquid silicone rubber is used as  
10 the sealant 11, it is also preferable to use elastic packing composed of an annular rubber band instead. In the case of using such elastic packing, although additional parts are required, disassembling work in maintenance becomes easier.

It is also preferable to temporarily fix the cover 1 onto the  
15 electronic substrate 7 by means of a screw instead of press fitting.

Further, it is also preferable that a room-temperature-setting liquid silicone rubber filled with a heat-transfer filler such as alumina, silica, etc. or a heat-transfer elastic insulating sheet is used as the heat-transfer soft insulating layer 19.

20 Although the fixing screws 15 are inserted from the base 8 side to the cover 1 side in the foregoing example, it is also preferable that a screw hole is provided on the base 8 side and a fixing screw is inserted from the cover 1 side to the base 8 side.